RISO, INC. **TECHNICAL INFORMATION BULLETIN**

Subject: NEW THERMAL HEAD CHART — Bulletin No.: 90

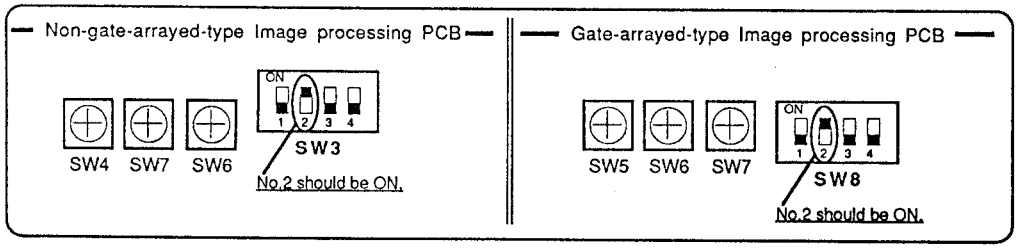
[ ] Factory Modification	Applies to:	Modification Schedule:	Factory Installed _____
[ ] Field Modification			
[ ] Safety Information	RC	[ ] TBS	Field Installed _____
[X] Technical Information	SERIES	[ ] Next Call	
[ ] General Information		[ ] Next PM	Fitting Time _____
[ ] Adv. Tech Information		[X] As Necessary	

A new Thermal Head Chart has been released for machines operating under low temperature conditions. Applies to System Main ROM versions S11/Ver.1.31 and above, S11G/Ver.5.14 and above, S22G/Ver.1.13 and above.

Voltage VTPH(V)	Resistance value R (Ω)	Switch setting SW3/SW4
18.0	1520-1542	C / B
	1543-1574	D / D
	1575-1601	E / E
18.0	1602-1623	C / C
	1624-1656	D / D
	1657-1686	E / E
18.5	1687-1703	9 / 9
	1704-1737	A / A
	1738-1775	B / B
18.5	1776-1789	9 / 9
	1790-1823	A / B
	1824-1858	B / C
	1859-1870	C / D
19.0	1871-1874	6 / 6
	1875-1911	7 / 8
	1912-1947	8 / 9
	1948-1969	9 / A
19.0	1970-2002	7 / 8
	2003-2038	8 / 9
	2039-2074	9 / B
19.0	2075-2093	7 / 9
	2094-2129	8 / A
	2130-2166	9 / B
	2167-2184	A / D
19.0	2185-2220	8 / B
	2221-2257	9 / C
	2258-2300	A / D

* "SW3" & "SW4" in the column of "Switch setting" of the above thermal power setting chart correspond to "SW5" & "SW8" of the Non-gate-arrayed-type Image processing PCB.

Change of DIP SW Setting on Image Processing PCB



Issue Date:	Effective Date:	Supersedes Bulletin:	Date:	Page No.
09/21/92	09/21/92		09/21/92	1 of: 1